# **Product Specifications**

Part Number⁵	OCL¹ (µН) ±30%	rms ( <b>A</b> )	l <sub>sat</sub> (A)	DCR (mΩ) typical @ 20°C	DCR (mΩ) maximum @ 20°C	K-factor⁴
DR1040-1R5-R	1.35	6.5	10	6.0	8.1	15.5
DR1040-2R5-R	2.4	6.1	7.8	7.0	9.0	12.0
DR1040-3R8-R	3.6	5.5	6.4	9.6	13	9.9
DR1040-5R2-R	5.2	5.4	5.5	14	17	8.3
DR1040-7R0-R	6.8	4.5	4.8	17	20	7.2
DR1040-8R2-R	8.1	3.98	4.6	24	29	6.4
DR1040-100-R	9.6	3.8	4.4	26	35	5.7
DR1040-150-R	14.9	3.1	3.6	37	50	4.7
DR1040-220-R	21.1 ±20%	2.5	2.9	54	73	4.0
DR1040-330-R	32.6	2.2	2.45	69	93	3.3
DR1040-470-R	45.8	1.9	2.1	95	128	2.8
DR1040-680-R	65.3	1.42	1.65	152	183	2.3
DR1040-820-R	87	1.29	1.47	214	260	2.0
DR1040-101-R	101	1.25	1.35	225	304	1.9
DR1040-151-R	148	0.85	1.15	356	430	1.6
DR1040-221-R	216	0.70	0.92	530	640	1.3
DR1040-331-R	323	0.52	0.70	810	1090	1.0

1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.25 Vrms, 0.0 Adc, +25 °C

2. I<sub>mm</sub>: DC current for an approximate temperature rise of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125 °C under worst case operating conditions verified in the end application.
3. I<sub>mm</sub>: Peak current for approximately 35% rolloff @ +25 °C

(K-factor from table), L: (Inductance in  $\mu$ H),  $\Delta$ I (Peak to peak ripple current in Amps).. 5. Part Number Definition: DR1040-xxx-R

DR1040 = Product code and size

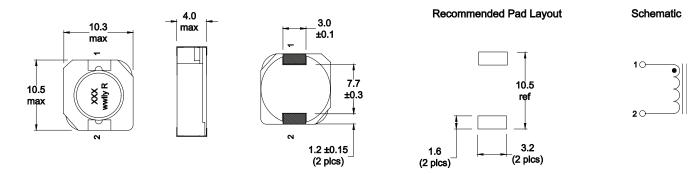
-xxx= inductance value in µH, R= decimal point,

If no R is present then last character equals number of zeros

4. K-factor: K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K \* L \* Δl. Bp-p: (mT), K:

-R suffix = RoHS compliant

# **Dimensions (mm)**

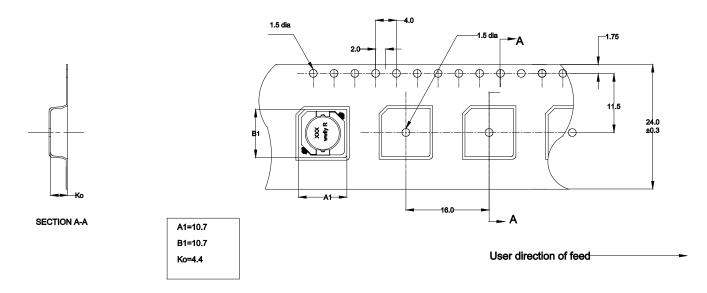


Part marking: inductance value in uH. R = decimal point. If no R is present then last character equals number of zeroes. wwlly = date code, R = revision level

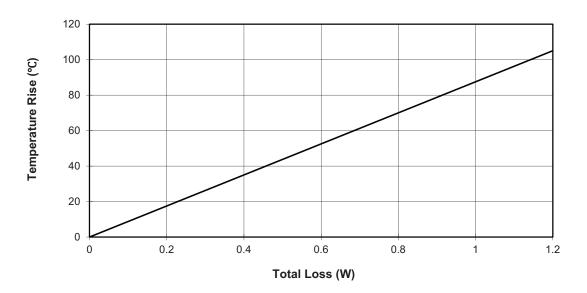
Do not route traces or vias underneath the inductor

# Packaging information (mm)

Supplied in tape and reel packaging , 850 parts per 13" diameter reel

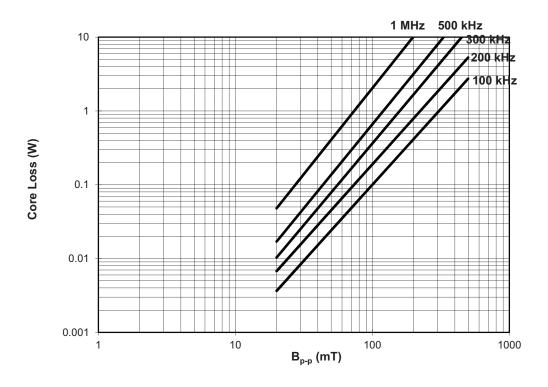


## Temperature rise vs. total loss

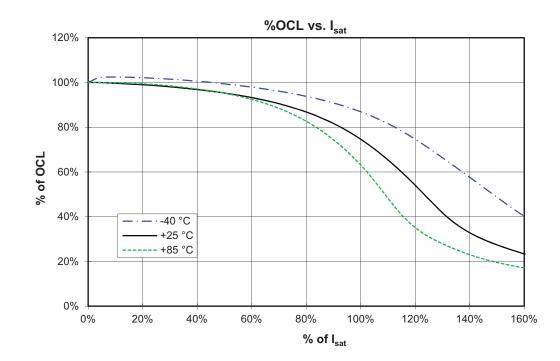


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# Core loss vs. B<sub>p-p</sub>

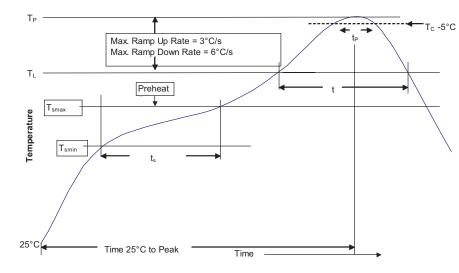


# Inductance characteristics



# DR1040 Shielded power inductors

### Solder reflow profile



### Table 1 - Standard SnPb Solder (T<sub>c</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

### Table 2 - Lead (Pb) Free Solder (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

## **Reference JDEC J-STD-020D**

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T <sub>smin</sub> )	100°C	150°C	
• Temperature max. (T <sub>smax</sub> )	150°C	200°C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds	
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$	20 Seconds**	30 Seconds**	
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

\* Tolerance for peak profile temperature (Tn) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

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